Electronic Patent Application Fee Transmittal							
Application Number:	10560405						
Filing Date:	12-Dec-2005						
Title of Invention:	Method of bonding microstructured substrates						
First Named Inventor/Applicant Name:	Isabelle Chartier						
Filer:	Suvashis Bhattacharya/Monica Pizarro						
Attorney Docket Number:	034299-678						
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Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 3 months with \$0 paid		1253	1	1110	1110		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			1110